

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

## **Product image**





OMNIMATE<sup>®</sup> 4.0 follows the trend of One Cable Technology (OCT). The modular concept enables the fast configuration of hybrid interfaces, which transmit data, signals and energy in a single connector. As a result, you can reduce the cabling effort in a wide variety of applications, simplify maintenance and accelerate automation processes. The unique SNAP IN connection is the backbone and speeds up the wiring process.

#### The fastest connection yet

- Fast, safe, and tool-free wiring due to unique SNAP IN connection
- Ready for Robot through "wire ready" delivery with open clamping point
- · Optical and acoustic feedback indicates proper wiring

## Create your own configuration

- Flexible configuration and ordering via the Weidmüller Configurator (WMC)
- Dispatch within three days even for individually configured products
- Automatic offer preparation for the configurated product

# Simply configuration of modular hybrid connectors















- Flexible combination options for power, signal and data transmission
- Future-proof Single-Pair Ethernet technology

#### General ordering data

Version	PCB plug-in connector, male header, THT/THR solder connection, Pitch in mm (P): 5.00 mm, Number of poles: 3, 270°, Tube
Order No.	8000072503
Туре	MHS 5/03 W T3 B T
GTIN (EAN)	4064675330806
Qty.	33 pc(s).
Product data	IEC: 400 V / 26.8 A UL: 300 V / 18.5 A
Packaging	Tube

Creation date October 27, 2022 8:47:29 AM CEST



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## **Technical data**

## **Dimensions and weights**

Depth	14 mm	Depth (inches)	0.551 inch
Height	14.1 mm	Height (inches)	0.555 inch
Height of lowest version	10.9 mm	Width	16.38 mm
Width (inches)	0.645 inch	Net weight	4.317 g

## **System specifications**

Type of connection		Mounting onto the PCB	THT/THR solder
	Board connection		connection
Pitch in mm (P)	5 mm	Pitch in inches (P)	0.197 inch
Outgoing elbow	270°	Number of poles	3
Number of solder pins per pole	1	Solder pin length (I)	3.2 mm
Solder pin dimensions	1.0 x 1.0 mm	Solder eyelet hole diameter (D)	1.4 mm
Solder eyelet hole diameter tolerand	ce (D)+ 0,1 mm	Outside diameter of solder pad	2.3 mm
Template aperture diameter	2.1 mm	L1 in mm	10 mm
L1 in inches	0.394 inch	Number of rows	1
Pin series quantity		Touch-safe protection acc. to DIN VDE	Touch-safe above the
	1	57 106	printed circuit board
Touch-safe protection acc. to DIN VI	DE	Protection degree	
0470	IP 20	-	IP20
Volume resistance	≤5 mΩ	Plugging cycles	≥ 25
Plugging force/pole, max.	8.5 N	Pulling force/pole, max.	8.5 N

#### **Material data**

PA 9T	Colour	black
RAL 9011	Insulating material group	I
≥ 600	Moisture Level (MSL)	1
V-0	Contact base material	CuMg
CuMg	Contact surface	tinned
matt	Storage temperature, min.	-25 °C
55 ℃	Operating temperature, min.	-50 °C
100 °C		
	RAL 9011 ≥ 600 V-0 CuMg matt 55 °C	RAL 9011 Insulating material group  ≥ 600 Moisture Level (MSL)  V-0 Contact base material  CuMg Contact surface  matt Storage temperature, min.  55 °C Operating temperature, min.

## Rated data acc. to IEC

tested acc. to standard	JEO 00004 4 JEO 04004	Rated current, min. number of poles	00.04
	IEC 60664-1, IEC 61984	(Tu=20°C)	26.8 A
Rated current, max. number of poles (Tu=20°C)	19.7 A	Rated current, min. number of poles (Tu=40°C)	23.1 A
Rated current, max. number of poles (Tu=40°C)	16.9 A	Rated voltage for surge voltage class / pollution degree II/2	400 V
Rated voltage for surge voltage class / pollution degree III/2	320 V	Rated voltage for surge voltage class / pollution degree III/3	250 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	4 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	4 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	4 kV	Clearance, min.	4 mm
Creepage distance, min.	5.4 mm		

## Rated data acc. to UL 1059

Rated voltage (Use group B / UL 1059)	) 300 V	Rated voltage (Use group D / UL 1059)	300 V
Rated voltage (Use group F / UL 1059)	420 V	Rated current (Use group B / UL 1059)	18.5 A
Rated current (Use group D / UL 1059	) 10 A	Clearance distance, min.	4 mm
Creepage distance, min.	5.6 mm		_

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## **Technical data**

#### Classifications

ETIM 6.0	EC002637	ETIM 7.0	EC002637
ETIM 8.0	EC002637	ECLASS 9.0	27-44-04-02
ECLASS 9.1	27-44-04-02	ECLASS 10.0	27-44-04-02
ECLASS 11.0	27-46-02-01	ECLASS 12.0	27-46-02-01

#### Important note

IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
Notes	<ul> <li>Rated current related to rated cross-section &amp; min. No. of poles.</li> </ul>
	• P on drawing = pitch
	<ul> <li>Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards.</li> </ul>

#### • Diameter of solder eyelet D = 1.4+0.1mm

• Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months

#### **Downloads**

Engineering Data	CAD data – STEP	
Catalogues	Catalogues in PDF-format	



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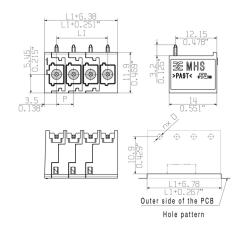
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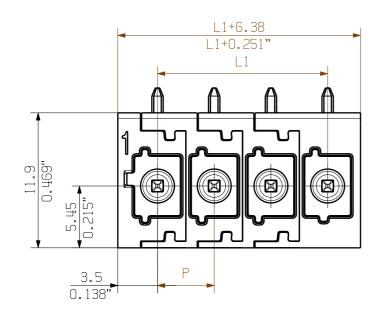
## **Drawings**

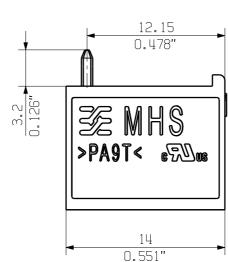
## **Product image**

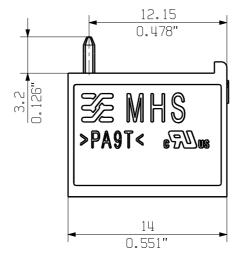


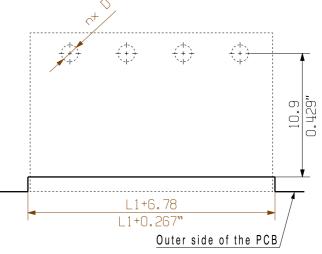
## **Dimensional drawing**



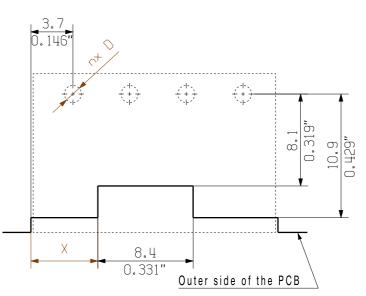








Hole pattern using MPS 5 without middle flange lever



Hole pattern using MPS 5 with middle flange lever

12		55.00	2.165	25.90	1.020
11		50.00	1.969	25.90	1.020
10		45.00	1.772	20.90	0.823
9		40.00	1.575	20.90	0.823
8		35.00	1.378	15.90	0.626
7		30.00	1.181	15.90	0.626
6		25.00	0.984	10.90	0.429
5		20.00	0.787	10.90	0.429
4		15.00	0.591	5.90	0.232
3		10.00	0.394	5.90	0.232
2		5.00	0.197	0.90	0.035
n		L1	L1	χ	Χ
Pol	es	[mm]	[inch]	[mm]	[inch]
Prim ERP Part No.: .					

Drawing no.

0

Issue no

Further Dim. & Info. See data sheet

DIN I

Scale: ./.

Drawings Assembly

General tolerance: DIN ISO 2768-mK					M 1/1
	B000400			Prim PLM	Part No.: .
ROMS	P038108 ·	Max. nos.		Weidmülle	
	First Issue Date				
	27.01.2021	Modifi	cation		
			Date	Name	
		Drawn	27.01.2021	Tauber-Reglin,	M

Stuckmann, Pet

Product file:

07.04.2021 | Sapina, Svetos

Responsible

Size: A3 Approved

MHS 5/... W T3 ...

For the mounting of PCBs, it should be noted that the rated data relates only to the PCB components

The neccessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to IEC 664 / VDE 0110.

The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine. Weidmueller PCB components are tested according to the DIN EN 61984 or to the DIN EN 60947-7-4 standard,

and are valid for its field of application. Provided that the components are used to the intended purpose, all requirements with respect to the occuring of electrical, mechanical, thermic and corrosive stress will be satisfied.



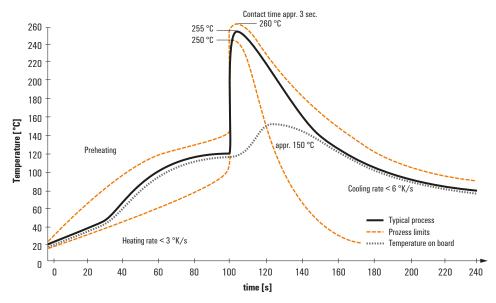
## Recommended wave solderding profiles

#### Weidmüller Interface GmbH & Co. KG

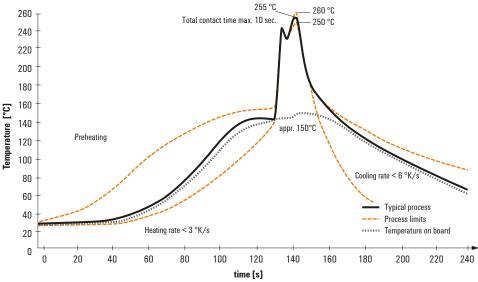
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## Single Wave:



#### **Double Wave:**



## Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

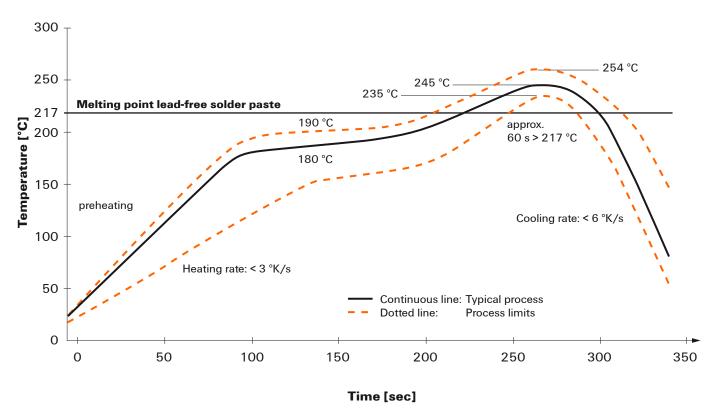


## Recommended reflow soldering profile

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## **Reflow soldering profile**

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- · Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically  $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at  $\geq$  -6K/s solder is cured. Board and components cool down while avoiding cold cracks.